

3N50K-MK **Power MOSFET** 

# 3A, 500V **N-CHANNEL POWER MOSFET**

### **DESCRIPTION**

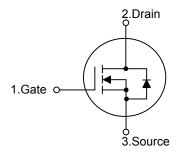
The UTC 3N50K-MK is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation

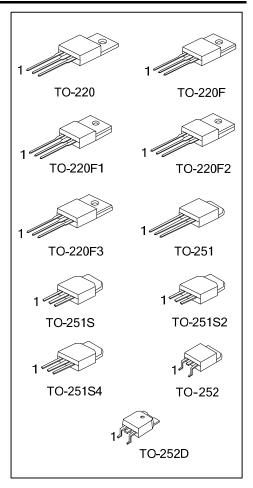
The UTC 3N50K-MK is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 3.20 @  $V_{GS}$  = 10V,  $I_{D}$  = 1.5A
- \* High Switching Speed
- \* 100% Avalanche Tested

### **SYMBOL**



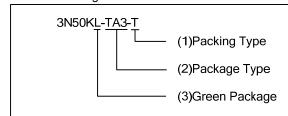


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### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N50KL-TA3-T	3N50KG-TA3-T	TO-220	G	D	S	Tube	
3N50KL-TF3-T	3N50KG-TF3-T	TO-220F	G	D	S	Tube	
3N50KL-TF1-T	3N50KG-TF1-T	TO-220F1	G	D	S	Tube	
3N50KL-TF2-T	3N50KG-TF2-T	TO-220F2	G	D	S	Tube	
3N50KL-TF3-T	3N50KG-TF3-T	TO-220F3	G	D	S	Tube	
3N50KL-TM3-T	3N50KG-TM3-T	TO-251	G	D	S	Tube	
3N50KL-TMS-T	3N50KG-TMS-T	TO-251S	G	D	S	Tube	
3N50KL-TMS2-T	3N50KG-TMS2-T	TO-251S2	G	D	S	Tube	
3N50KL-TMS4-T	3N50KG-TMS4-T	TO-251S4	G	D	S	Tube	
3N50KL-TN3-R	3N50KG-TN3-R	TO-252	G	D	S	Tape Reel	
3N50KL-TND-R	3N50KG-TND-R	TO-252D	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



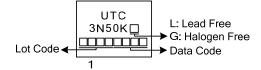
- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F3, TM3: TO-251

TMS: TO-251S, TMS2: TO-251S2,

TMS4: TO-251S4, TN3: TO-252, TND: TO-252D

(3) L: Lead Free, G: Halogen Free and Lead Free

### **MARKING**





## **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	500	V	
Gate-Source Voltage		$V_{GSS}$	±30	V	
Danier Commont	Continuous (T <sub>C</sub> =25°C)	$I_D$	3 (Note 5)	Α	
Drain Current	Pulsed (Note 2)	$I_{DM}$	12 (Note 5)	Α	
Avalanche Current (Note 2)		$I_{AR}$	3	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	150	mJ	
Peak Diode Recovery dv/dt	(Note 4)	dv/dt	4.5	V/ns	
	TO-220		75	W	
	TO-220F/TO-220F1		25	W	
	TO-220F3		25	VV	
Power Dissipation	TO-220F2	$P_{D}$	26	W	
	TO-251/TO-251S				
	TO-251S2/TO-251S4		50	W	
	TO-252/TO-252D				
	TO-220		0.5	W/°C	
	TO-220F/TO-220F1		0.2	W/°C	
	TO-220F3		0.2	VV/ C	
Derate above 25°C	TO-220F2	$P_D$	0.208	W/°C	
	TO-251/TO-251S				
	TO-251S2/TO-251S4		0.4	W/°C	
	TO-252/TO-252D				
Power Dissipation		P <sub>D</sub>	36	W	
Derate above 25°C			0.288	W/°C	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature		$T_{STG}$	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 33.3 mH,  $I_{AS}$  = 3A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 3A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$
- 5. Drain current limited by maximum junction temperature.

## THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient  Junction to Case	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3		62.5	°C/W	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D	$ heta_{ m JA}$	110		
	TO-220		1.67		
	TO-220F/TO-220F1 TO-220F3	$\theta_{ m JC}$	4.9		
	TO-220F2		4.8	°C/W	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D	А	18 18 2.50 M		
WWW. Flying I 60					
UTC UNISONIC TECHNOLOGIES CO., LTD				3 of 7	

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub>=25°C, unless otherwise noted)

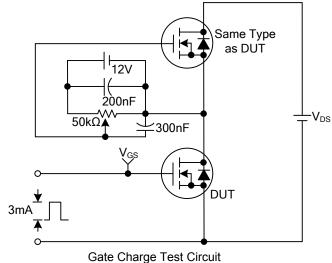
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		$BV_{DSS}$	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V				V	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V			1	μΑ	
Gate- Source Leakage Current	Forward	1000	$V_{GS}$ =+30V, $V_{DS}$ =0V			+100	nA	
	Reverse		V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	3.0		5.0	V	
Static Drain-Source On-State Re	sistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.5A			3.2	Ω	
DYNAMIC PARAMETERS					-	=.		
Input Capacitance		$C_{ISS}$			415	530	pF	
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		250	350	pF	
Reverse Transfer Capacitance		$C_{RSS}$	1		50	60	pF	
SWITCHING PARAMETERS					-	=.		
Turn-ON Delay Time		t <sub>D(ON)</sub>			42	60	ns	
Rise Time		$t_R$	$V_{DD}$ =30V, $I_{D}$ =0.5A, $R_{G}$ =25 $\Omega$		18	25	ns	
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	(Note 1, 2)		103	130	ns	
Fall-Time		$t_{F}$			18	25	ns	
Total Gate Charge		$Q_G$	\\ -10\\\\\ -50\\\\\-13A		10	13	nC	
Gate to Source Charge		$Q_GS$	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A		1.5		nC	
Gate to Drain Charge		$Q_GD$	(Note 1, 2)		5.5		nC	
SOURCE- DRAIN DIODE RATIN	NGS AND C		STICS		ā.	-		
Maximum Body-Diode Continuous Current		Is				3	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				12	Α	
Drain-Source Diode Forward Voltage		$V_{SD}$	I <sub>S</sub> =3A, V <sub>GS</sub> =0V			1.4	V	

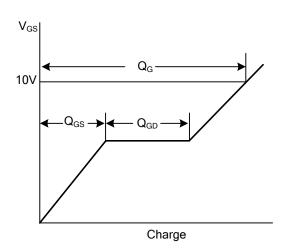
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

2. Essentially independent of operating temperature

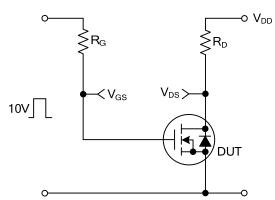


## **TEST CIRCUITS AND WAVEFORMS**

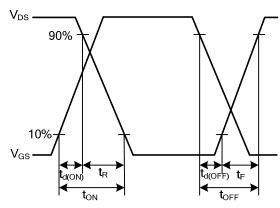




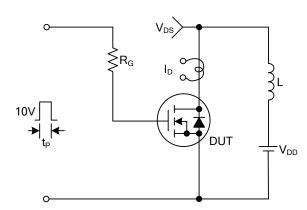
Gate Charge Waveforms



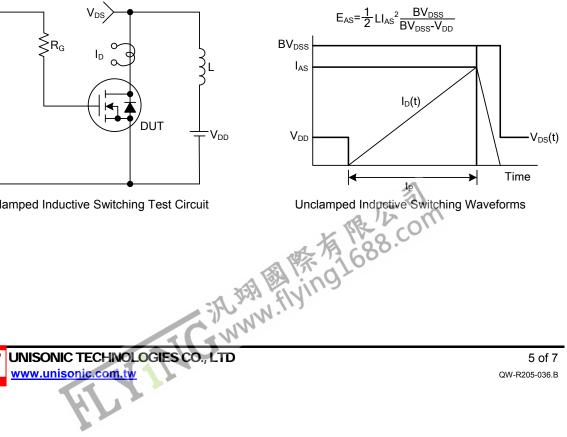




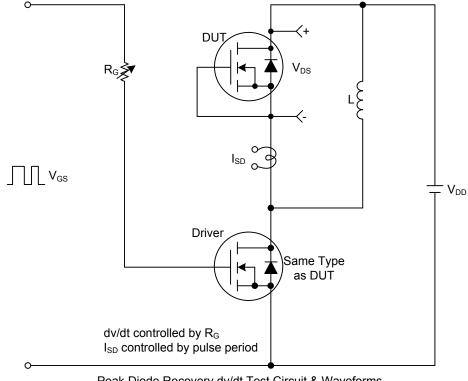
Resistive Switching Waveforms



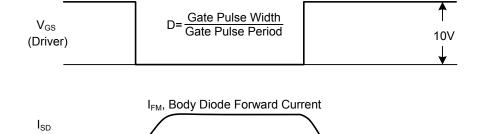
Unclamped Inductive Switching Test Circuit



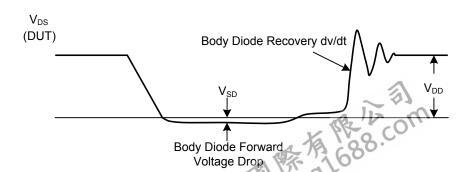
# **TEST CIRCUITS AND WAVEFORMS(Cont.)**



Peak Diode Recovery dv/dt Test Circuit & Waveforms

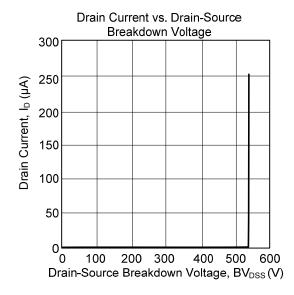


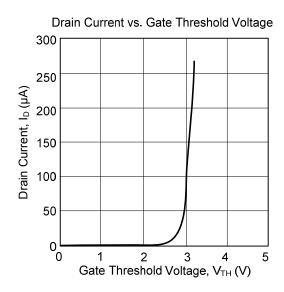
di/dt  $I_{RM}$ Body Diode Reverse Current

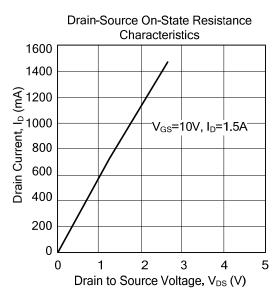


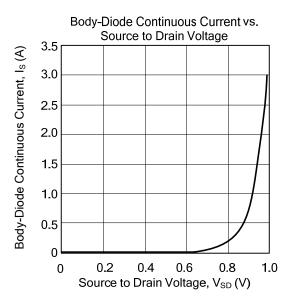
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### ■ TYPICAL CHARACTERISTICS









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